This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

1.-16. (canceled)

17. (currently amended) An electrotransport device comprising:

a reservoir and a non-conductive housing for the reservoir that comprises a substantially flexible electrically conductive element integrally molded within the non-conductive housing,

the electrically conductive element comprising

an electrode end positioned within the non-conductive housing and coated with an electrode coating;

a connecting portion coated with a connecting coating comprising a flexible polymer; and

a contact end positioned outside the non-conductive housing and coated with a contact coating;

~~wherein a first portion of the conductive element is within the non-conductive housing and a second portion of the element is disposed on the outside of the non-conductive housing and extends therefrom,~~

~~and~~ wherein a substantially liquid and moisture-impermeable bond is created between the material forming the non-conductive housing and the conductive element.

18. (previously presented) The electrotransport device of claim 17, wherein the non-conductive housing is a single integral component.

19. (previously presented) The electrotransport device of claim 18, wherein the electrotransport device is manufactured without the fabrication of openings or other passages through the non-conductive housing.

20. (previously presented) The electrotransport device of claim 17, wherein the conductive element comprises a substantially planar member.

21. (previously presented) The electrotransport device of claim 17, wherein the conductive element includes a base member having a conductive coating disposed thereon.

22. (new) The electrotransport device of claim 17, wherein the connection coating contains conductive particles.